




SPECIFICATION SHEET

SPECIFICATION SHEET NO.	N920-SMAES1J000S160
DATE	Sept. 20, 2021
REVISION	A1
DESCRIPTION	<p>SMD Super Fast Recovery Rectifier, SMA series, ES1J Type, 2 Pads</p> <p>Reverse recovery Time 35 ns Max.</p> <p>Reverse Voltage 600V Max. Forward Current 1.0A Max.</p> <p>Operating Temp. Range -55°C ~+150°C</p> <p>Package in Tape/Reel, 5000pcs/13" Reel</p> <p>RoHS/RoHS III compliant</p>
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	MDD ES1J
PART CODE	SMAES1J000S160

VENDOR APPROVE		
Issued/Checked/Approved		
		
DATE: Sept. 20, 2021		

CUSTOMER APPROVE
DATE:

SMD SUPER FAST RECOVERY RECTIFER SMA SERIES



MAIN FEATURE

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Low reverse leakage
- Built-in strain relief
- High forward surge current capability
- High temperature soldering guaranteed: 250°C/ 10 seconds at terminals
- Glass passivated chip junction

APPLICATION

- For SMD application

RFQ

[Request For Quotation](#)

PART CODE GUIDE

SMA	ES1J000	S	160
1	2	3	4

- 1) **SMA**: SMD Super Fast Recovery Rectifier, SMA/DO-214AC series code
- 2) **ES1J000**: Type code for ES1J
- 3) **S**: Package code, Tape/reel, 5000pcs/13" reel.
- 4) **160**: Specification code for Forward Current 1.0A Max. Reverse Voltage 600V Max.

MORE ITEMS AVAILABLE

SMAES1A000S105	SMAES1B000S110	SMAES1C000S115	SMAES1D000S120	SMAES1E000S130
SMAES1G000S140	SMAES1J000S160			
SMAES2A000S205	SMAES2B000S210	SMAES2C000S215	SMAES2D000S220	SMAES2E000S230
SMAES2G000S240	SMAES2J000S260			

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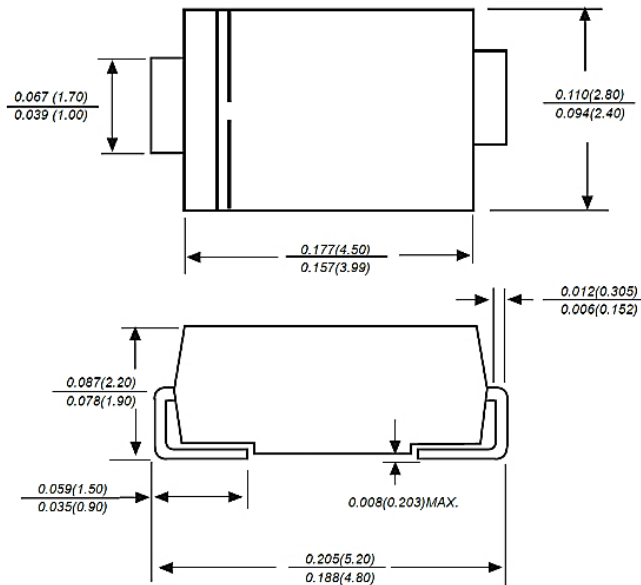
DIMENSION (Unit: Inch/mm)

Image for reference

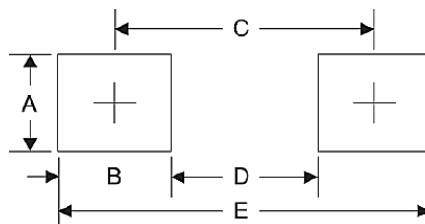


Marking: ES1J

SMA/DO-214AC



Recommend Pad Layout



Symbol	Unit (Inch)	Unit (mm)
A	0.066	1.680
B	0.060	1.520
C	0.154	3.900
D	0.095	2.410
E	0.215	5.450

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MECHANICAL DATA

Case	Terminals	Polarity	Mounting Position	Weight per piece
JEDEC SMA/DO-214AC molded plastic body	Solder plated, Solderable per MIL-STD-750, Method 2026	Polarity symbol marking on case	Any	0.0020 Ounce, 0.0622 grams

MAX. RATING & CHARACTERISTICS

Parameter	SYMBOLS	VALUE			UNITS
		Min.	Typical	Max.	
Repetitive peak reverse voltage	V _{RRM}			600	Volts
RMS voltage	V _{RMS}			420	Volts
DC blocking voltage	V _{DC}			600	Volts
Average forward output rectified current at TL= 55°C	I _{AV}			1.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}		30		A
Instantaneous forward voltage at 1.0A	V _F			1.70	Volts
DC reverse current at rated DC blocking voltage	I _R	TA=25°C		5	µA
		TA=125°C		50	µA
Reverse recovery Time (Note 2)	t _{rr}			35	ns
Junction capacitance (NOTE 3)	C _J		15		pF
Thermal resistance (Note 4)	R _{QJA}		60		°C/W
Operating junction temperature range	T _J	-55		+150	°C
Storage temperature range	T _{STG}	-55		+150	°C

Note

- Ratings at 25 C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.
- Reverse recovery condition IF=0.5A,IR=1.0A,Irr=0.25A
- Measured at 1.0MHz and applied reverse voltage of 4.0Voltage
- P.C.B. mounted with 0.2x0.2"(5.0x5.0mm) copper pad areas.

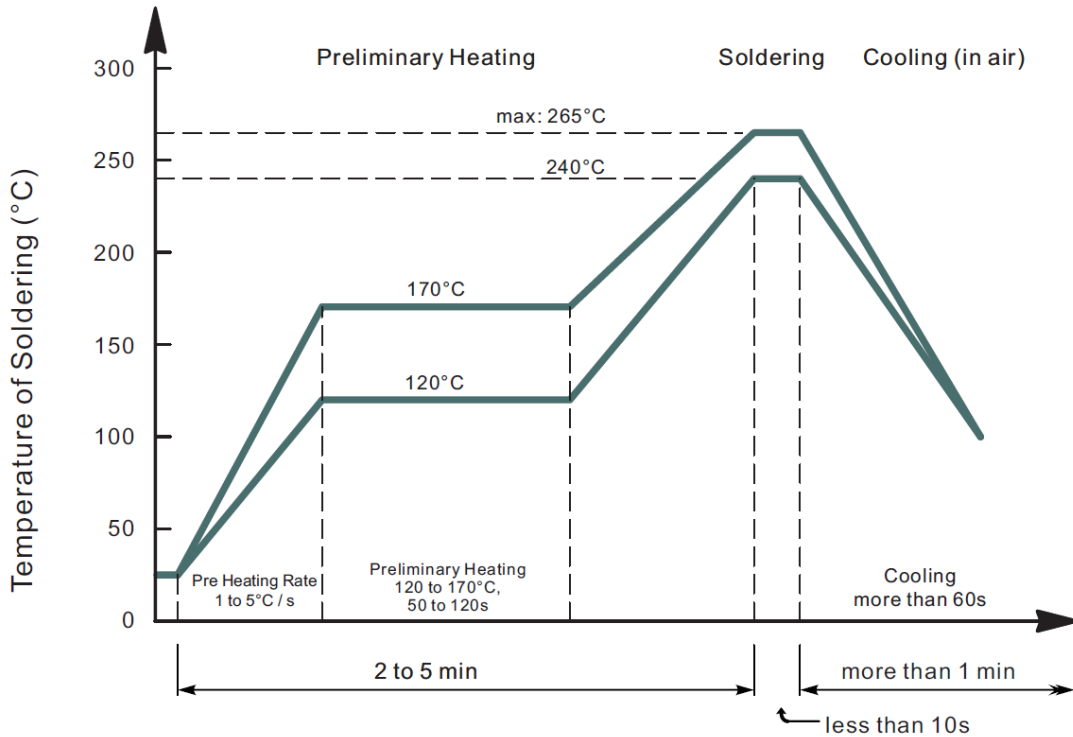
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RELIABILITY

Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, TA=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	TA=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

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SUGGESTED REFLOW PROFILE (For Reference Only)



- Recommended peak temperature is over 245°C, If peak temperature is below 245 °C, you may adjust the following parameters; time length of peak temperature (longer), time length of soldering (longer), thickness of solder paste (thicker)
- Welding shall not exceed 2 times
- Remark: lead free solder paste (96.5 sn/3.0 Ag/0.5Cu)

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RATINGS AND CHARACTERISTIC CURVES (For Reference Only)

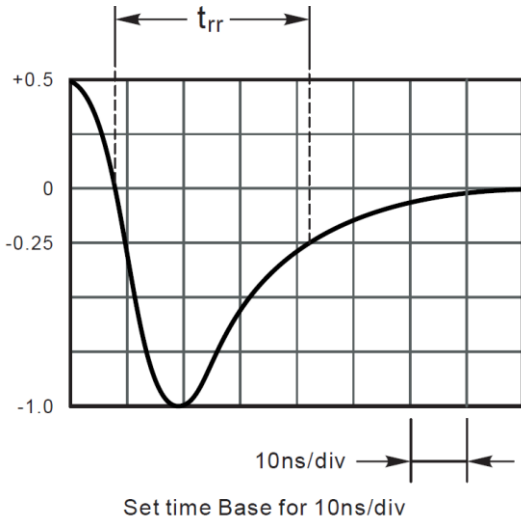


Fig.3 Typical Reverse Characteristics

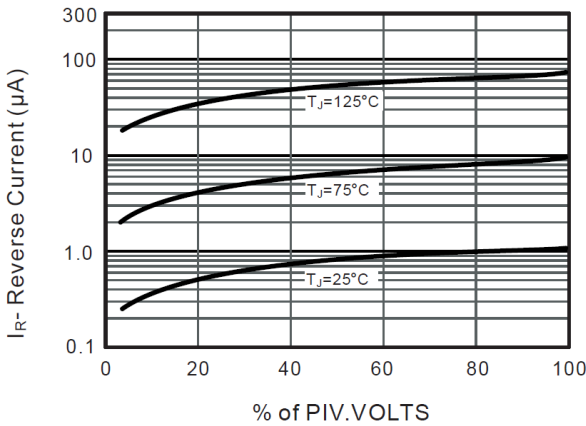


Fig.5 Typical Junction Capacitance

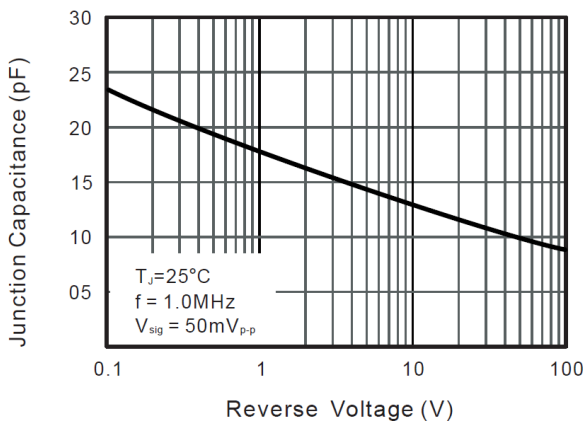


Fig.2 Maximum Average Forward Current Rating

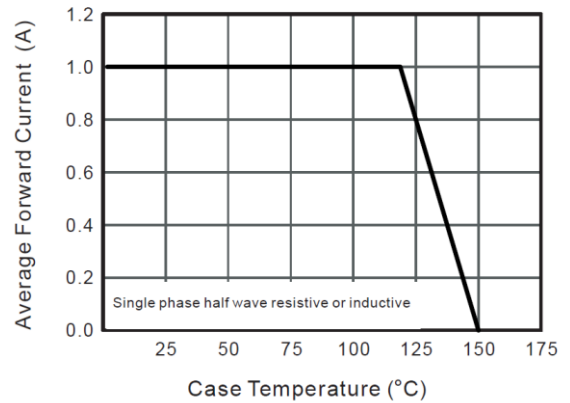


Fig.4 Typical Forward Characteristics

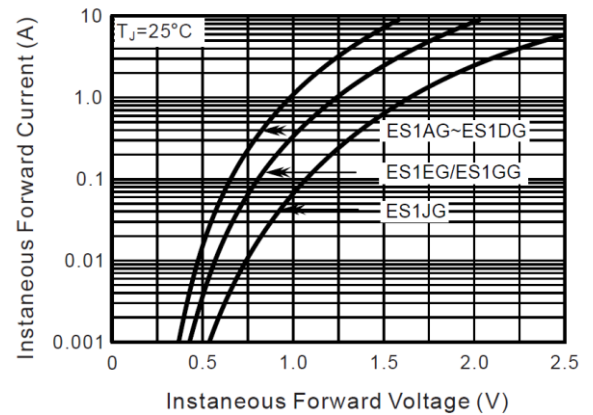
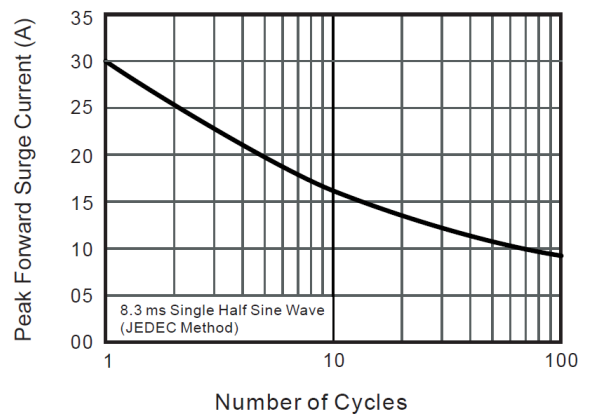


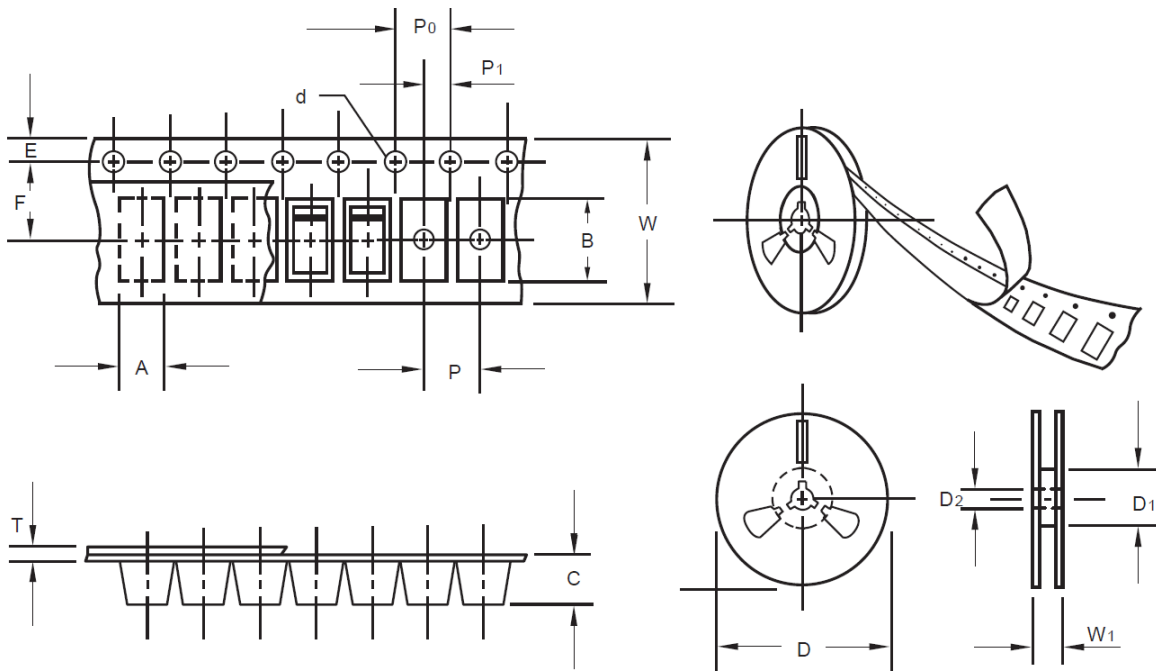
Fig.6 Maximum Non-Repetitive Peak Forward Surge Current



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TAPE/REEL (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-A and specifications.

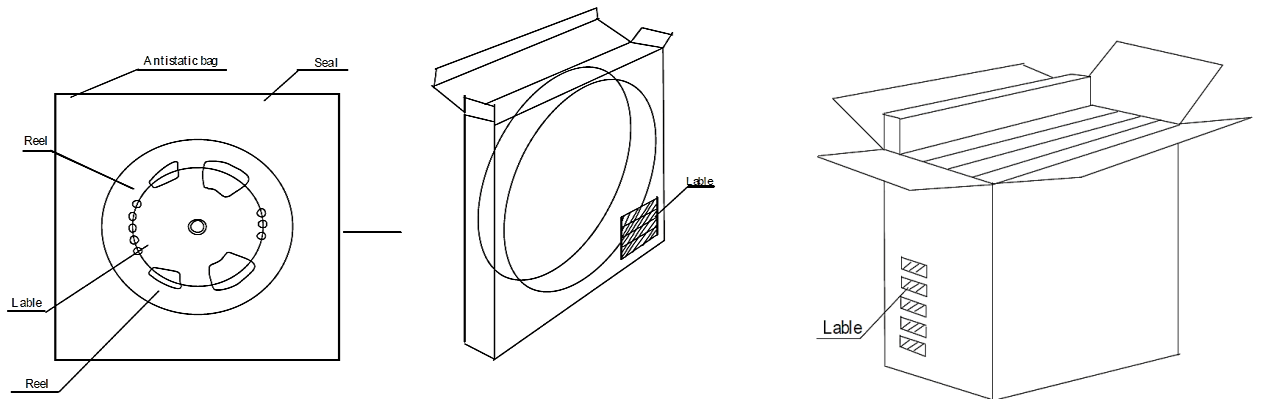


Item	Symbol	Tolerance	SMA/DO-214AC
Carrier width	A	0.1	2.8
Carrier Length	B	0.1	5.33
Carrier Depth	C	0.1	2.36
Sprocket hole	d	0.05	1.50
13" Reel outside diameter	D	2.0	330.0
13" Reel inner diameter	D1	-	50.0Min.
7" Reel outside diameter	D		
7" Reel inner diameter	D1		
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.0
Overall tape thickness	T	0.1	0.28
Tape width	W	0.3	12.00
Reel width	W1	1.0	18.0

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PACKAGE

Case Code	Reel Size	MPQ (pcs)	Component Spacing (mm)	Qty. Per Box (pcs)	Inner Box L*W*H (mm)	Reel Size (mm)	Carton size L*W*H (mm)	Qty. Per Carton (pcs)	G. W (kg)
SMA	13"	5,000		5,000	335*335*40	330	380*380*380	80,000	12.0



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